

G3VM-41PR11

MOS FET Relays

Smallest Class in market, USOP Package MOS FET Relays with Low Output Capacitance and ON Resistance (CxR=5pF·Ω)

- Dielectric strength of 500Vrms between I/O.



NEW

Note: The actual product is marked differently from the image shown here.

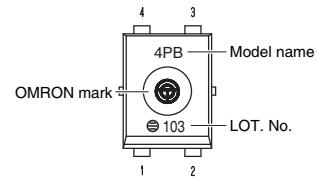
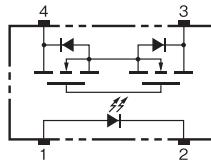
RoHS Compliant

Refer to "Common Precautions".

■ Application Examples

- | | |
|--------------------------------|---------------------------|
| • Semiconductor test equipment | • Communication equipment |
| • Test & measurement equipment | • Data loggers |

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) (See note.)	Model	Minimum package quantity	
					Number per tape & reel	
USOP4	1a (SPST-NO)	Surface-mounting terminals	40V	G3VM-41PR11	—	
				G3VM-41PR11 (TR05)	500	
				G3VM-41PR11 (TR)	1,500	

Note 1. Ask your OMRON representative for orders under 1,500 pcs or 500 pcs.

2. Tape-cut USOPs are packaged without humidity resistance. Use manual soldering to mount them. Refer to common precautions.

3. The AC peak and DC value is given for the load voltages.

■ Absolute Maximum Ratings (Ta = 25°C)

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1

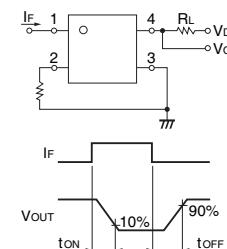
Item	Symbol	Rating	Unit	Measurement conditions
LED forward current	I _F	50	mA	
LED forward current reduction rate	ΔI _F /°C	-0.5	mA/°C	Ta≥25°C
LED reverse voltage	V _R	5	V	
Connection temperature	T _J	125	°C	
Load voltage (AC peak/DC)	V _{OFF}	40	V	
Continuous load current (AC peak/DC)	I _O	140	mA	
ON current reduction rate	ΔI _O /°C	-1.4	mA/°C	Ta≥25°C
Pulse ON current	I _{OP}	420	mA	t=100ms, Duty=1/10
Connection temperature	T _J	125	°C	
Dielectric strength between I/O (See note 1.)	V _{I-O}	500	Vrms	AC for 1 min
Ambient operating temperature	T _a	-40~+85	°C	With no icing or condensation
Ambient storage temperature	T _{STG}	-40~+125	°C	With no icing or condensation
Soldering temperature	—	260	°C	10s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25°C)

Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
LED forward voltage	V _F	1.0	1.15	1.3	V	I _F =10mA
Reverse current	I _R	—	—	10	μA	V _R =5V
Capacity between terminals	C _T	—	15	—	pF	V=0, f=1MHz
Trigger LED forward current	I _{FT}	—	1.0	3	mA	I _O =100mA
Maximum resistance with output ON	R _{ON}	—	7	10	Ω	I _F =5mA, I _O =140mA, t<1s
Current leakage when the relay is open	I _{LEAK}	—	—	1	nA	V _{OFF} =40V
Capacity between terminals	C _{OFF}	—	0.7	1.3	pF	V=0, f=100MHz, t<1s
Capacity between I/O terminals	C _{I-O}	—	0.4	—	pF	f=1MHz, Vs=0V
Insulation resistance between I/O terminals	R _{I-O}	1000	—	—	MΩ	V _{I-O} =500VDC, RoH≤60%
Turn-ON time	t _{ON}	—	0.04	0.2	ms	I _F =5mA, R _L =200Ω, V _{DD} =20V (See note 2.)
Turn-OFF time	t _{OFF}	—	0.14	0.2	ms	V _{DD} =20V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



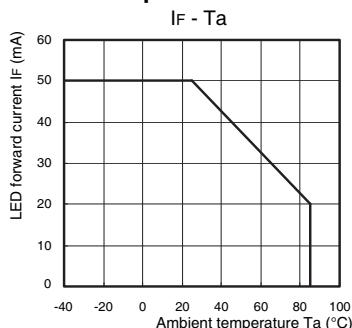
■Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

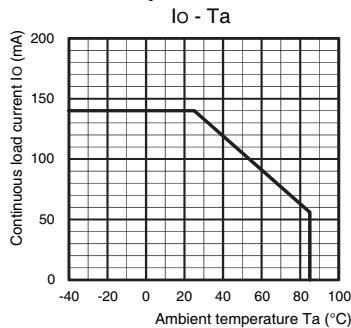
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	—	—	32	V
Operating LED forward current	I _F	5	7.5	20	mA
Continuous load current (AC peak/DC)	I _O	—	—	140	mA
Ambient operating temperature	T _a	-20	—	65	°C

■Engineering Data

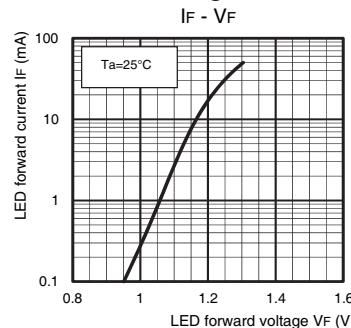
**LED forward current vs.
Ambient temperature**



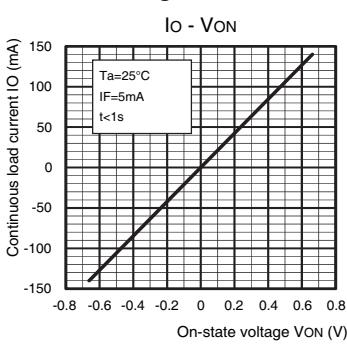
**Continuous load current vs.
Ambient temperature**



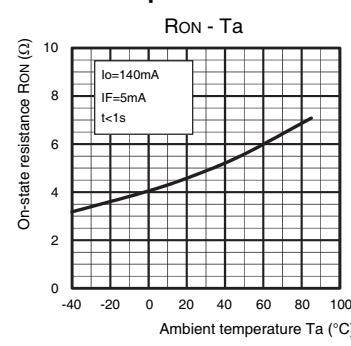
**LED forward current vs.
LED forward voltage**



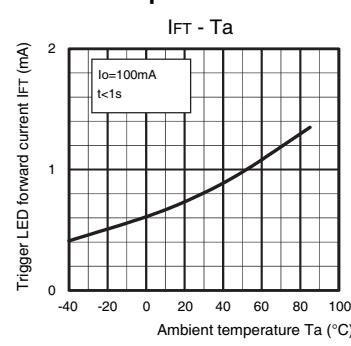
**Continuous load current vs.
On-state voltage**



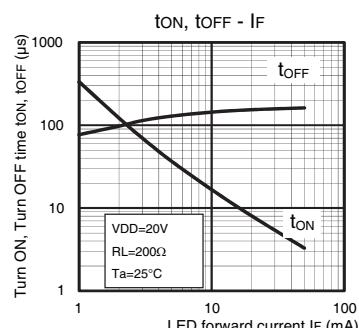
**On-state resistance vs.
Ambient temperature**



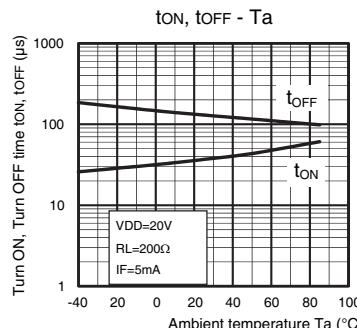
**Trigger LED forward current vs.
Ambient temperature**



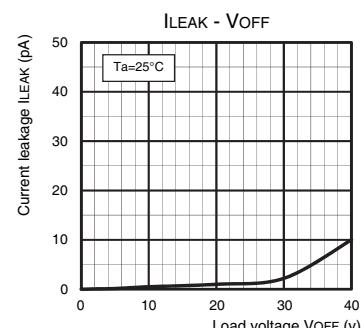
**Turn ON, Turn OFF time vs.
LED forward current**



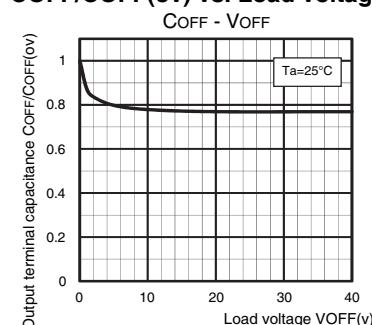
**Turn ON, Turn OFF time vs.
Ambient temperature**



**Current leakage vs.
Load voltage**



**Output terminal capacitance
COFF/COFF(OV) vs. Load voltage**



■Safety Precautions

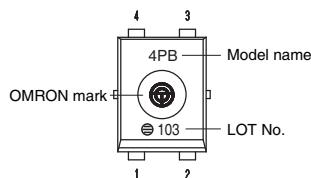
•Refer to "Common Precautions" for all G3VM models.

G3VM-41PR11

■Appearance

USOP (Ultra Small Outline Package)

USOP4



Note: The actual product is marked differently from the image shown here.

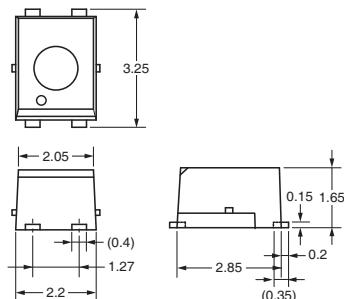
■Dimensions

(Unit: mm)



Surface-mounting Terminals

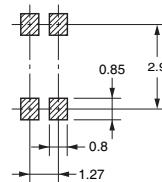
Weight: 0.03g



Note: The actual product is marked differently from the image shown here.

Actual Mounting Pad Dimensions

(Recommended Value, Top View)



- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

Cat. No. K207-E1-02

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